

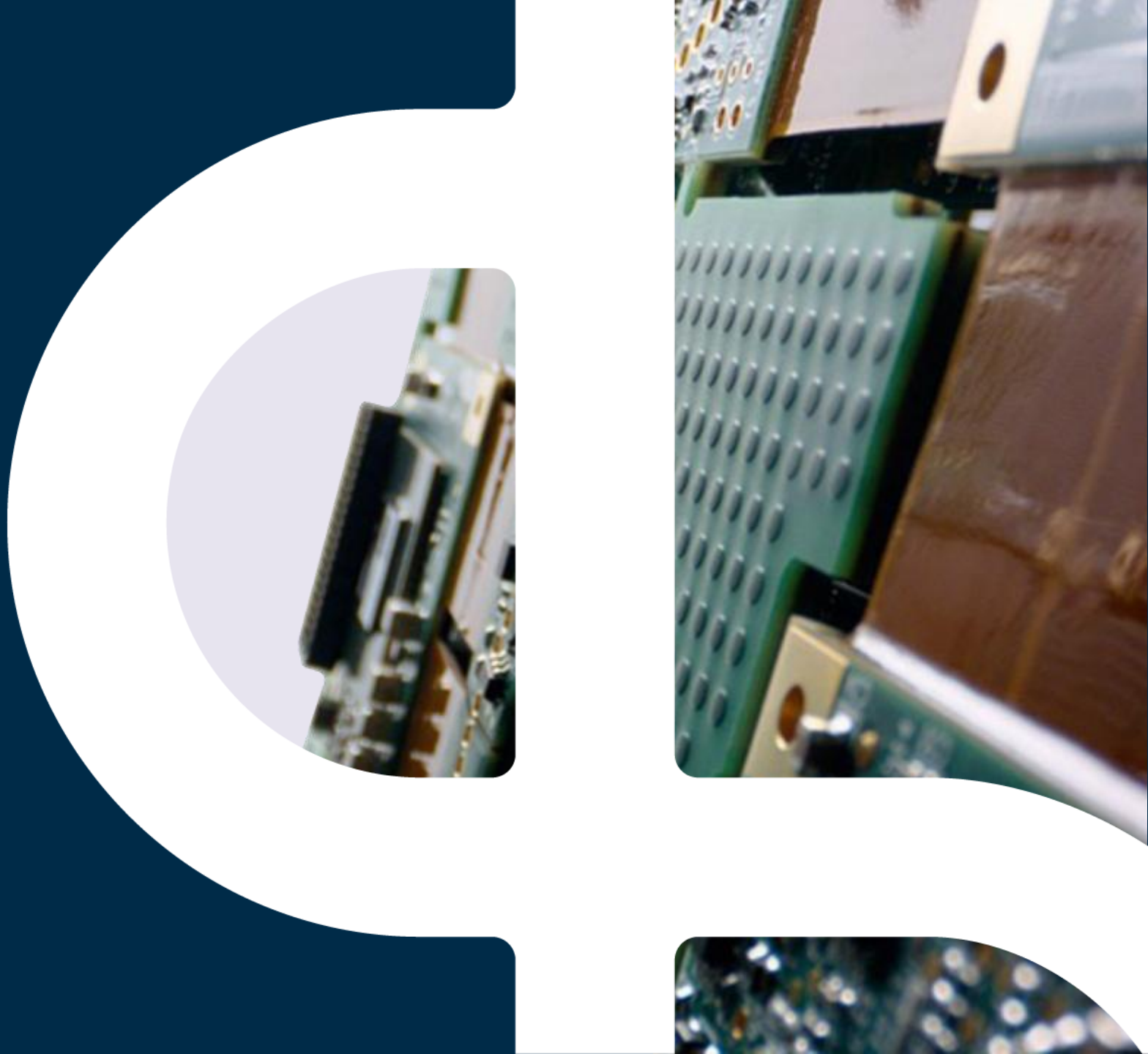


PCB All-in-One Solutions

Q3 2025

Company Presentation

Nov 2025



Forward looking statement

Disclaimer

The information contained herein is a summary only, and does not exhaust all the information about the Company or its operations, nor does it replace a review of the Company's Periodical or Annual Reports, or any other information which is filed and furnished with the Israel Securities Authority.

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PCB TECHNOLOGIES at a Glance

Providing All-in-One, Cutting-Edge Hardware Electronics Technology

Legacy:

Since 1981
HQ is in Israel
792 employees

Innovation:

Strong R&D and Engineering Team
New Products - 25% of Total Revenue
+100 customers programs

Diversified Customer Base: (2024)

50% Defense and Aerospace
23% Industrial Instruments
27% Medical

Market Opportunity Growth CAGR% 2025-2030:

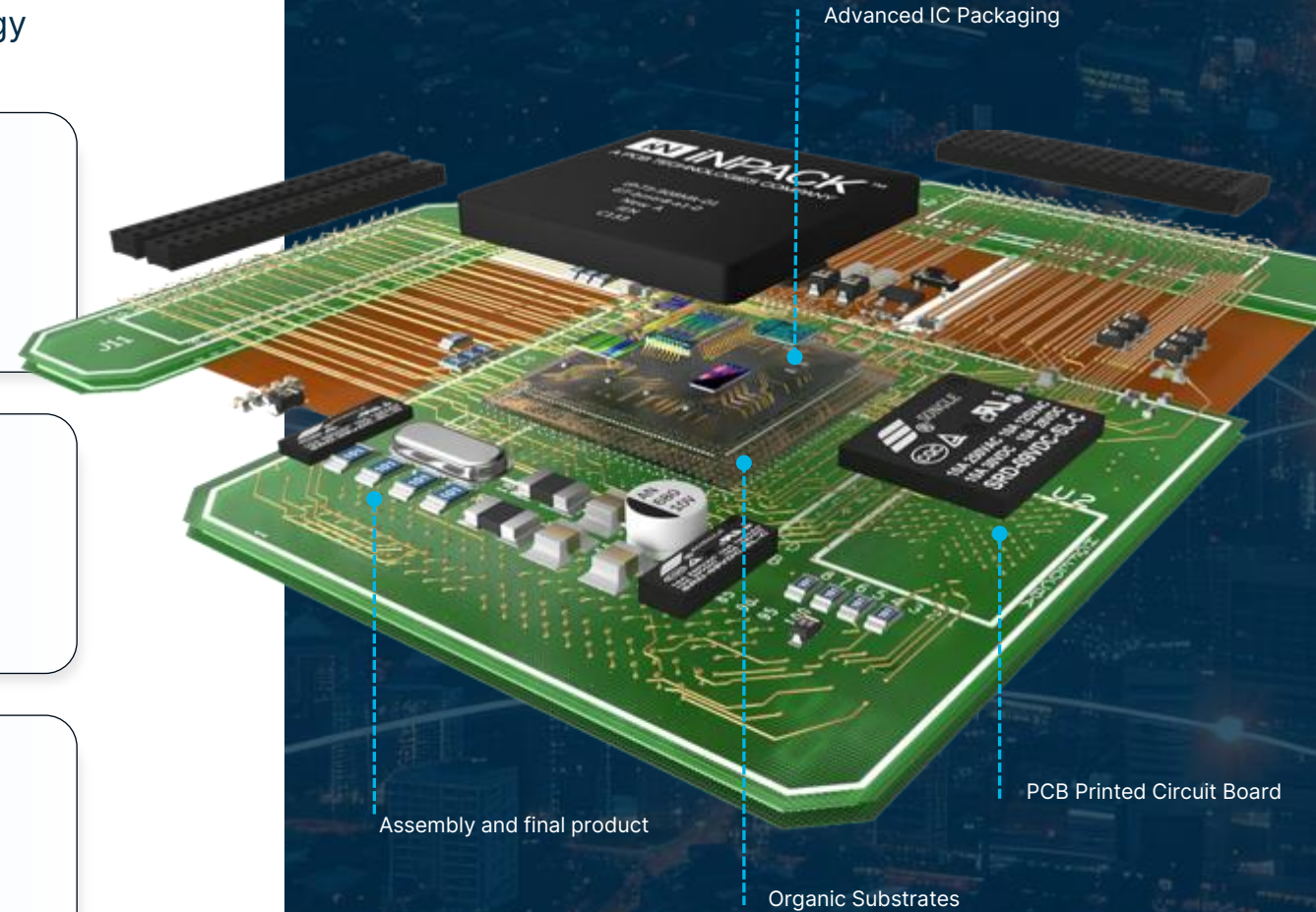
Defense and Aerospace 6.1%-8.5%
Industrial Instruments 5.8%-6.1%
Medical 5.6% -6.3%

Performance

(Q3-23 > Q3-25):
TTM Revenue– 174 M\$
CAGR Sales TTM : 13.5%
CAGR GP TTM : 61%
CAGR EBITDA TTM : 103%

Value Proposition:

One Site, All-in-One Solution:
Bridging PCB Fabrication, IC
Packaging, and Final Product
Integration



Sources: Yole, Mordor Intelligence

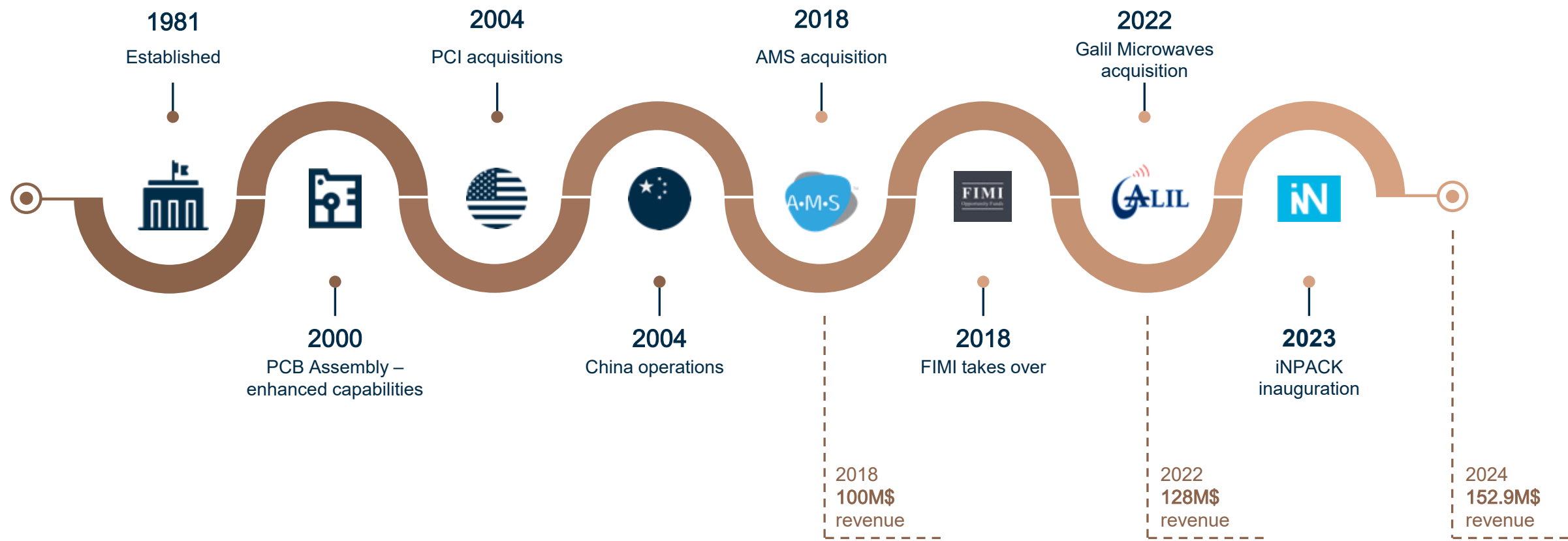


All in One Solutions

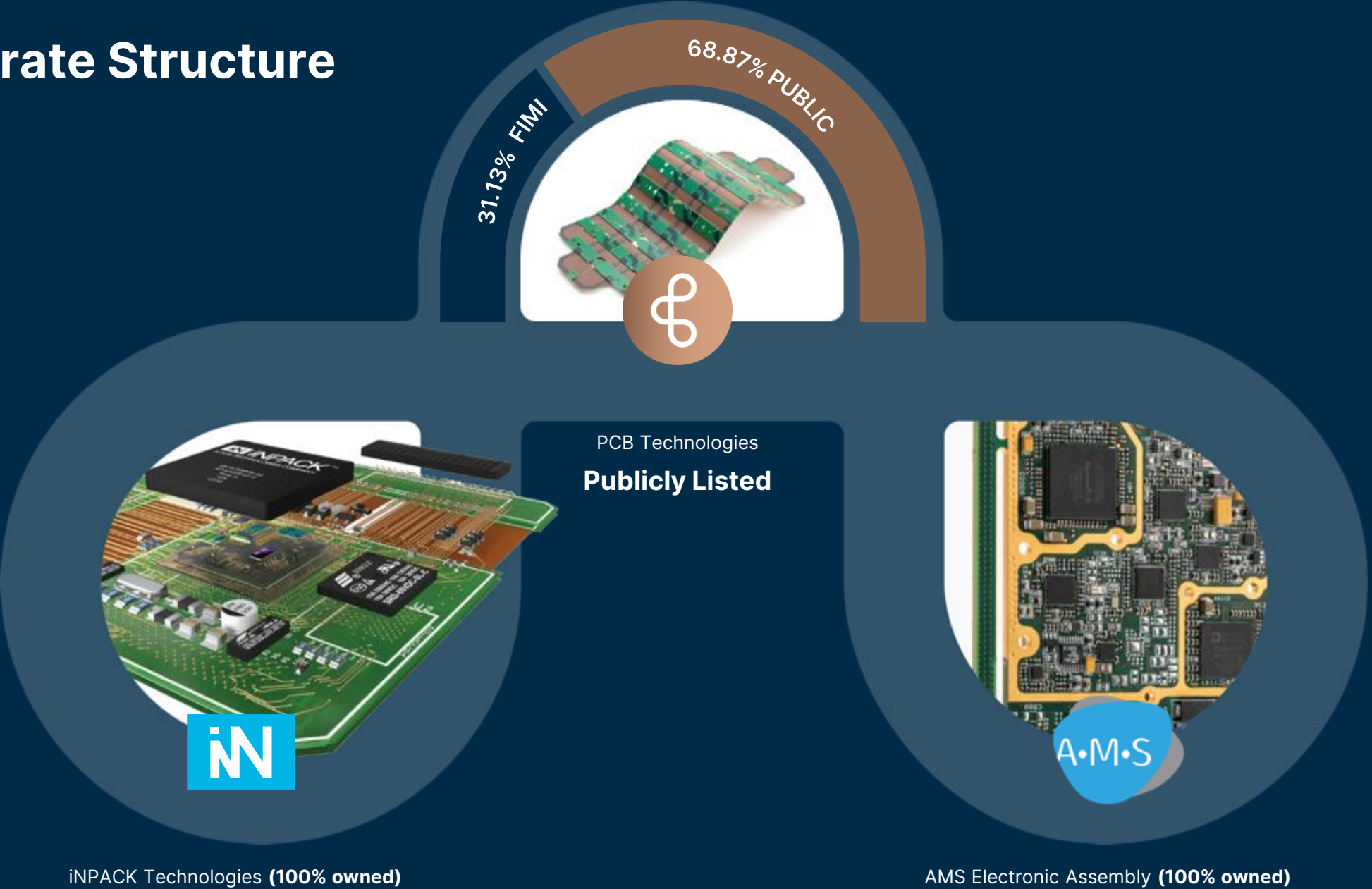
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3

Company History

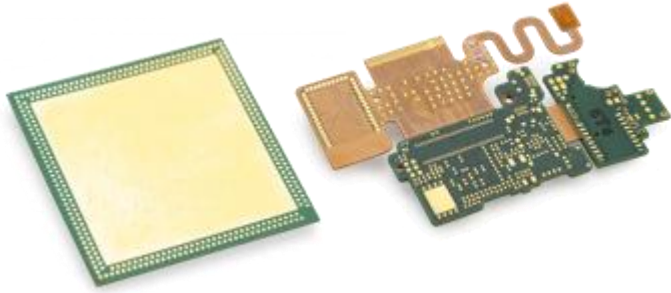


Corporate Structure



High-End Technologies

PCB Technologies Ltd. solutions enabling the most advanced electronics applications & technologies



PCBs & Substrates (Circuits Division)

- Printed circuit boards designed to support the most complex, high-density and powerful systems.
- Substrate design & manufacturing enabling high-performance solutions for analog, digital and high power.



IC Packaging (iNPACK Division)

- Complete design & manufacturing solution for the semiconductor industry.



PCBA & Final Product (Assembly Division)

- Comprehensive solutions from sub-assemblies to the final product, delivering precision and reliability for every electronics application.



... to enable High-End Applications

PCB Technologies Ltd. solutions enabling the most advanced electronics applications & technologies



Defense



Medical



Radar



ADAS

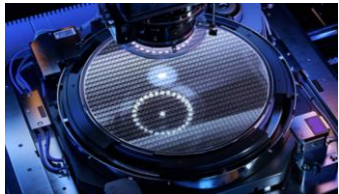


Drones



Medical

PCBs & Substrates



Industrial Instruments

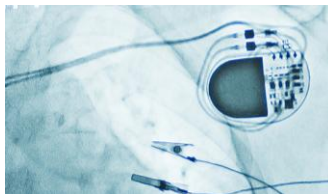


Aerospace

IC Packaging



RF Communication



Medical (Miniaturization)

PCBA + Final Product



Aggrotech



Defense



Providing Solutions for Leading Defense & Aerospace Programs



Optical Seeker - Navigation system



Eitan APC -
Radar System



Iron DOME -
Missile Program



Arrow 3 -
Antennas

OVER 100 PROGRAMS:

Providing PCB Solutions:

- High Frequency
- High Reliability
- High Power

Performance, durability & long life,
even in harsh conditions, serving:

- Top Tactical OEMs
- Military Branches & Intl. Ministries of Defense
- Commercial Space Applications & more



F35 -
Communication System



Active Protection -
Radar System



Aircraft Program
Landing & Comm. System



Impacting Medical Device Technology That Can Change Lives

END-TO-END FULL ASSEMBLY SOLUTION:

Utilizing our All-in-One
Methodology for
complete, complex
Medical Devices -
starting from PCB right
through to final product
assembly.



PCB Technologies
is ISO 13485 certified.



**Cardiac Navigation -
Complete System**



PCBA for MRI system



**Respiratory Monitoring -
Complete System**



Creating Precision Industrial Instruments for Complex Challenges

ALWAYS UP ON TECH:

Offering innovative solutions that provide both products and entire systems for a wide range of critical industrial sectors, including:
Semiconductor
Aggrotech, National Utility
Grids and the latest
Space-age Satellite
Communications Systems.



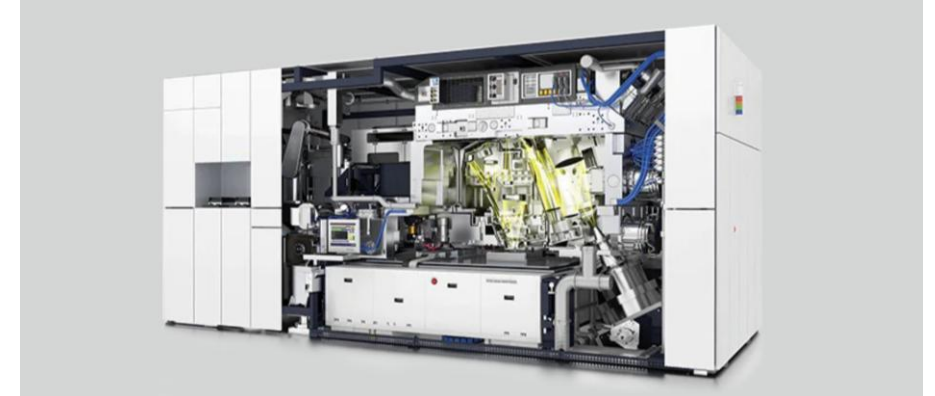
PCBA for 5G Satellites



Aggrotech Drones - Complete System



Water Meter Equipment - Complete System



Semiconductor - Heat Management control



Markets Mega Trends

Aerospace & Defense



Miniaturization



Integrated Systems



Laser Systems



Satellite-based Operations

Medical Technologies



Miniaturization



Telemedicine



3D Printing



Cybersecurity

Industrial Instrumentation



Hyperscale's



ML



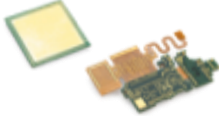
LLM's



Generative AI



End-Market Growth Drivers & Outlook

Segment	Company Share from 2024 Revenue	US+EU Total *EMS Market Size 2024 (B\$)	 PCB & Substrate Market Size(B\$)	 IC Packaging Market Size (B\$)	 Assembly & Final Product Market Size (B\$)	Company Addressable Market 2024 (B\$)	Segment CAGR % (2025-2030)
Aerospace & Defense	50%	45	5	2	38	7.2	6.1%--8.5%
Medical Technologies	23%	32	3	2	27	3.7	5.8%--6.1%
Industrial Instruments	27%	41	4	2	35	4.7	5.6%--6.3%
Total		118	12	6	100	15.6	

*Electronic Manufacturing Services

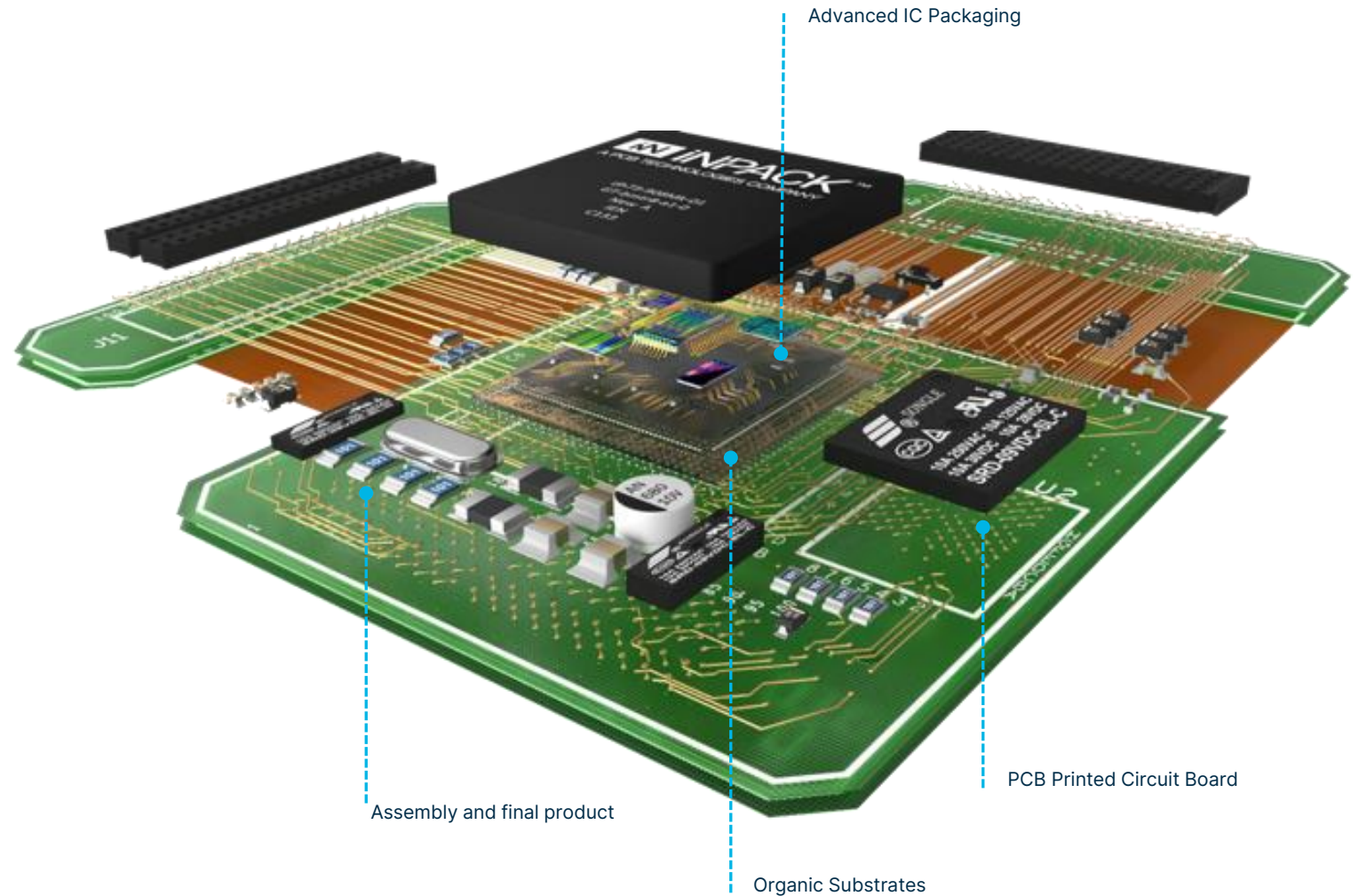
Sources: Mordor Intelligence, K.B.V Research



Unique ONE-STOP SHOP for integrated cutting-edge Hardware Electronics Manufacturing

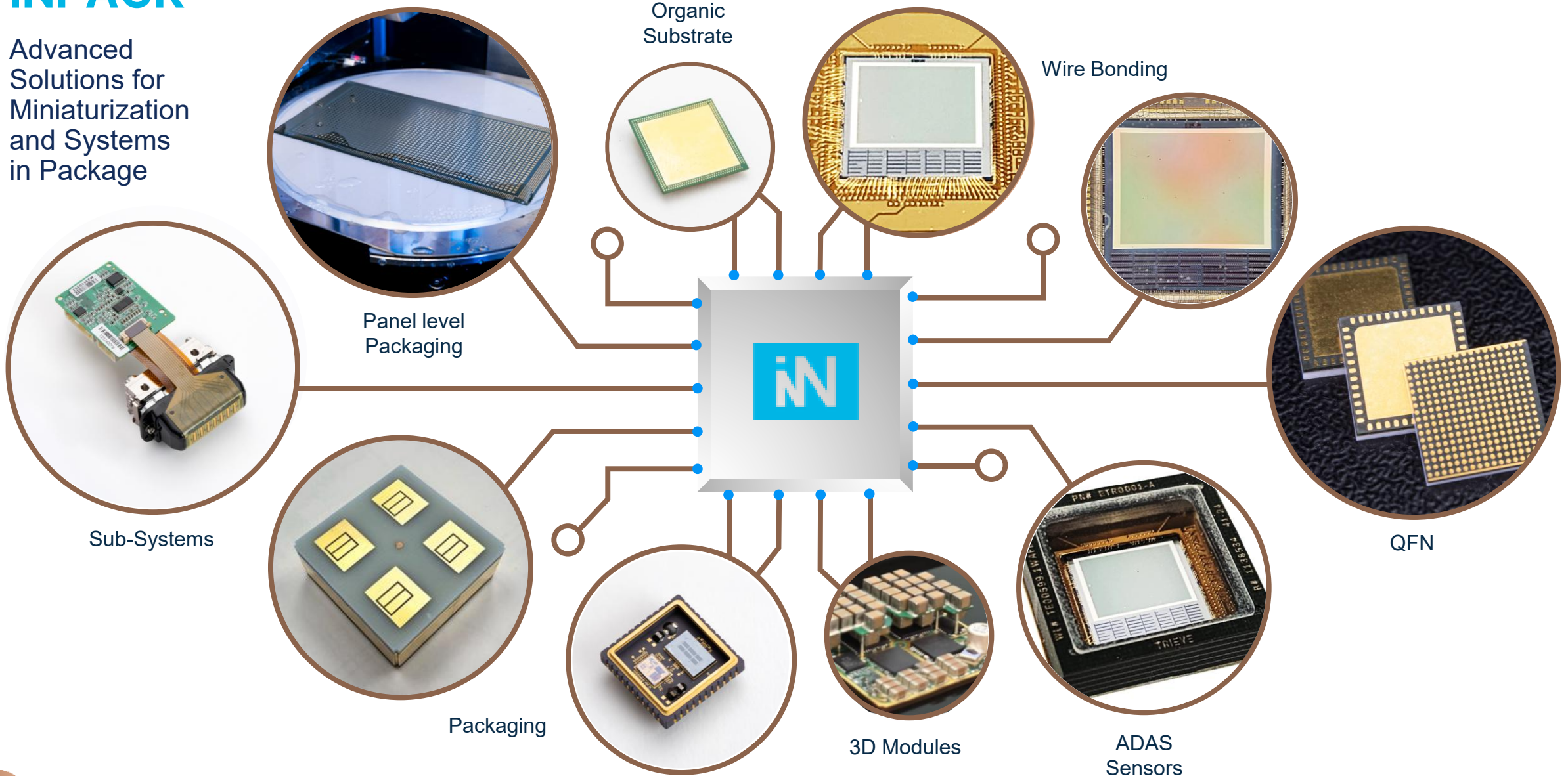
Added Value to Customers:

- ✓ Improved time to market
- ✓ Better yield processes
- ✓ More flexibility in design
- ✓ Smarter customization
- ✓ Lower development costs
- ✓ From prototype to mass production



iNPACK

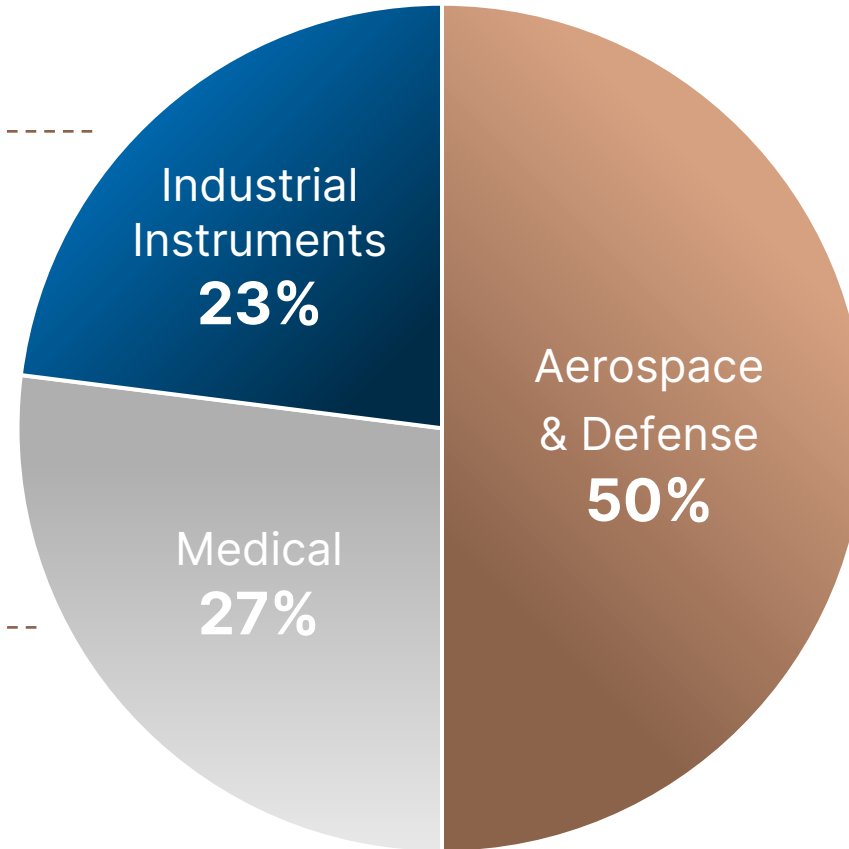
Advanced
Solutions for
Miniaturization
and Systems
in Package





Key Business Highlights

Diversified end-market mix with a growing Aerospace & Defense segment

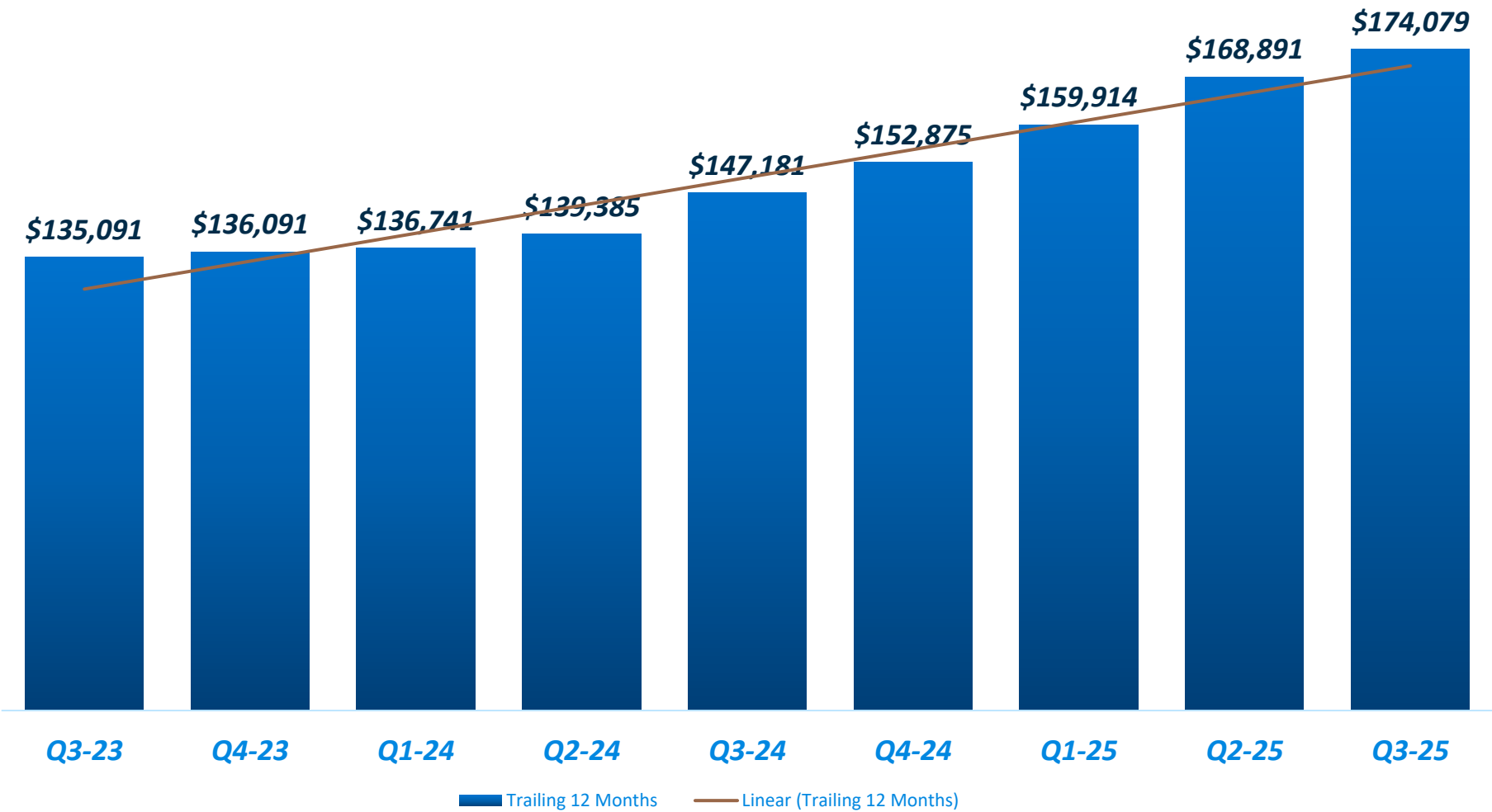


Based on 2024 \$153M Sales By Main Industries

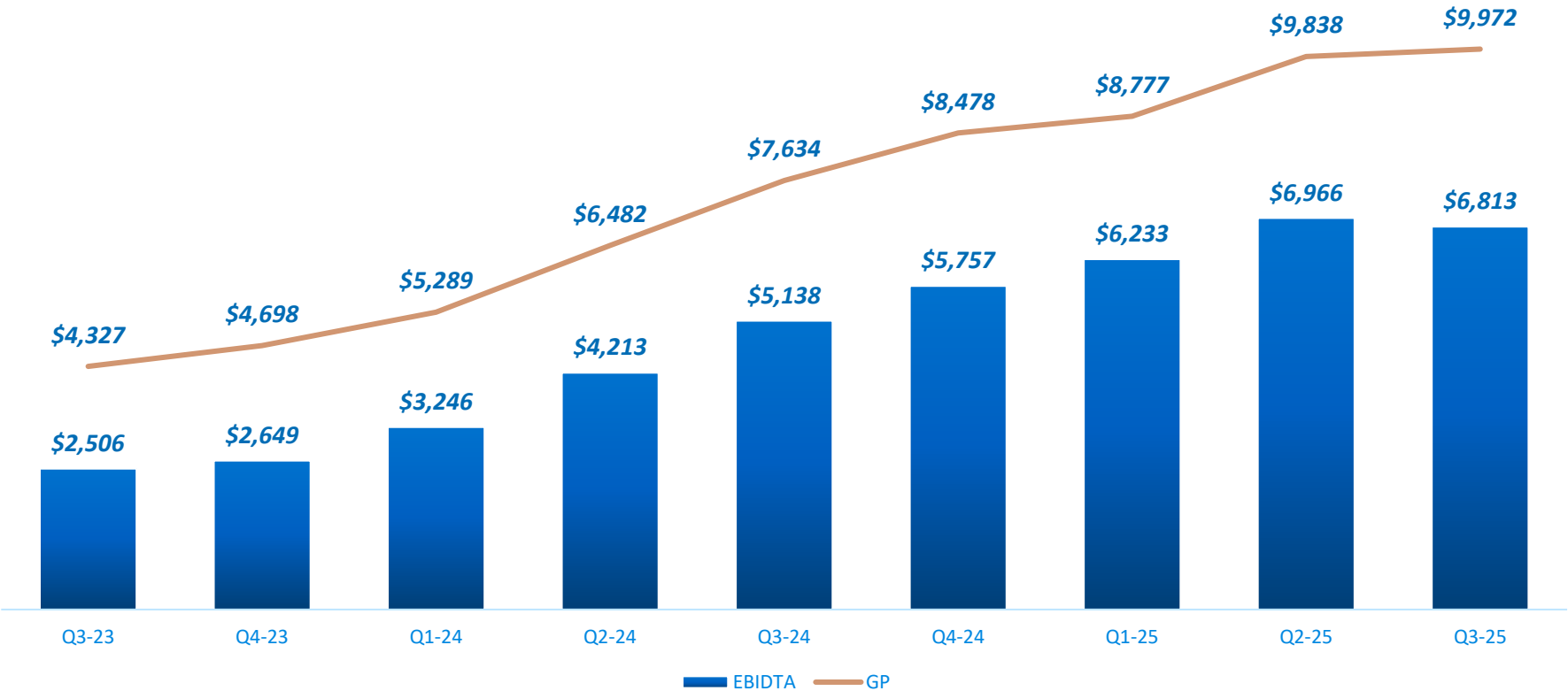


Sales Trend K\$ (TTM)

Sales CAGR: 13.5%



Consolidate EBITDA & GP Trends K\$

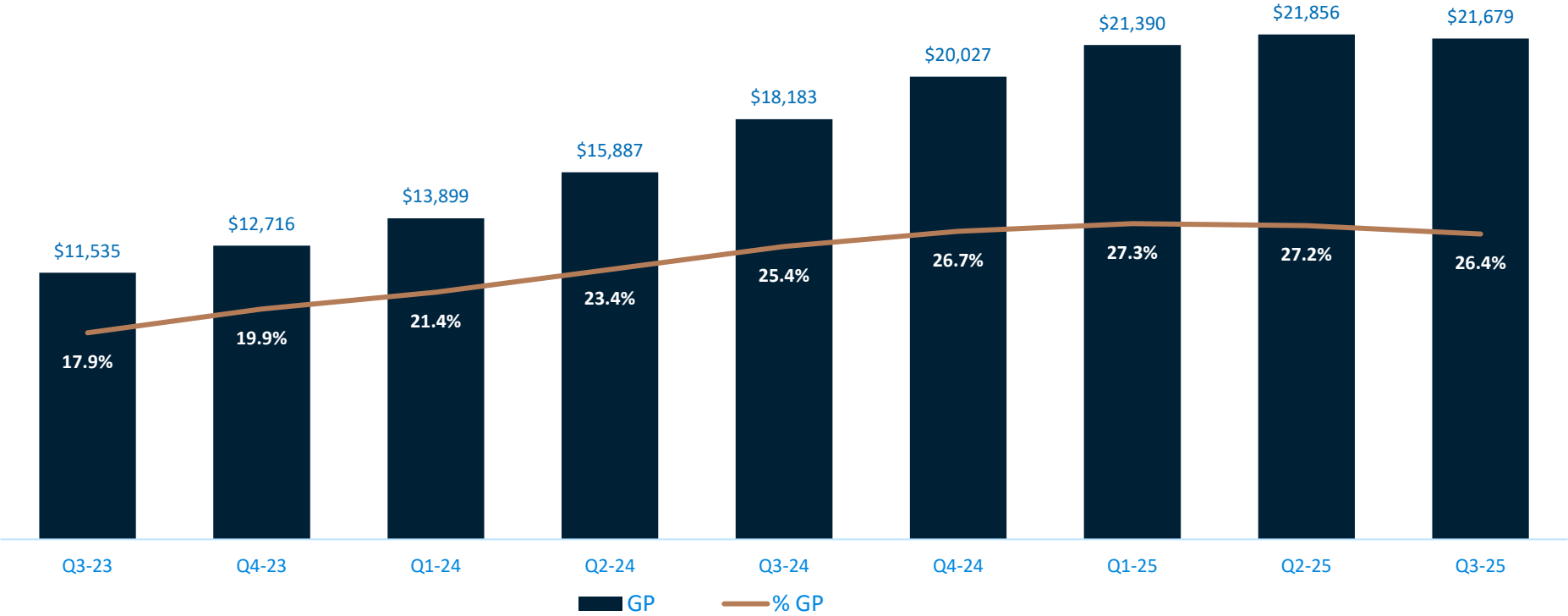


CAGR GP TTM Q3-23>>Q3-25: 60.8%
CAGR EBITDA TTM Q3-23>>Q3-25: 103%

Ongoing improvement in operational efficiency and product mix



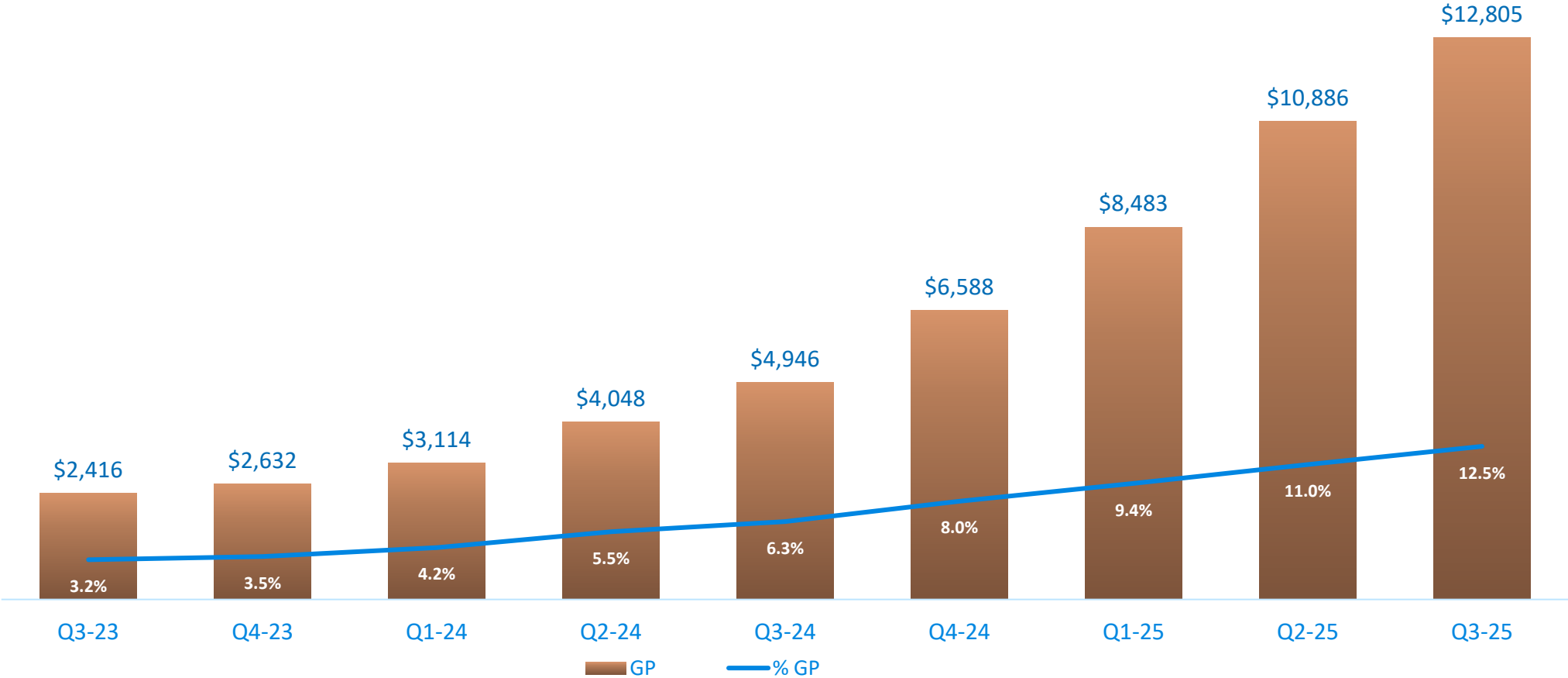
Circuits Division TTM GP K\$ Trend



CAGR GP TTM Q3-23 >> Q3-25: 37%



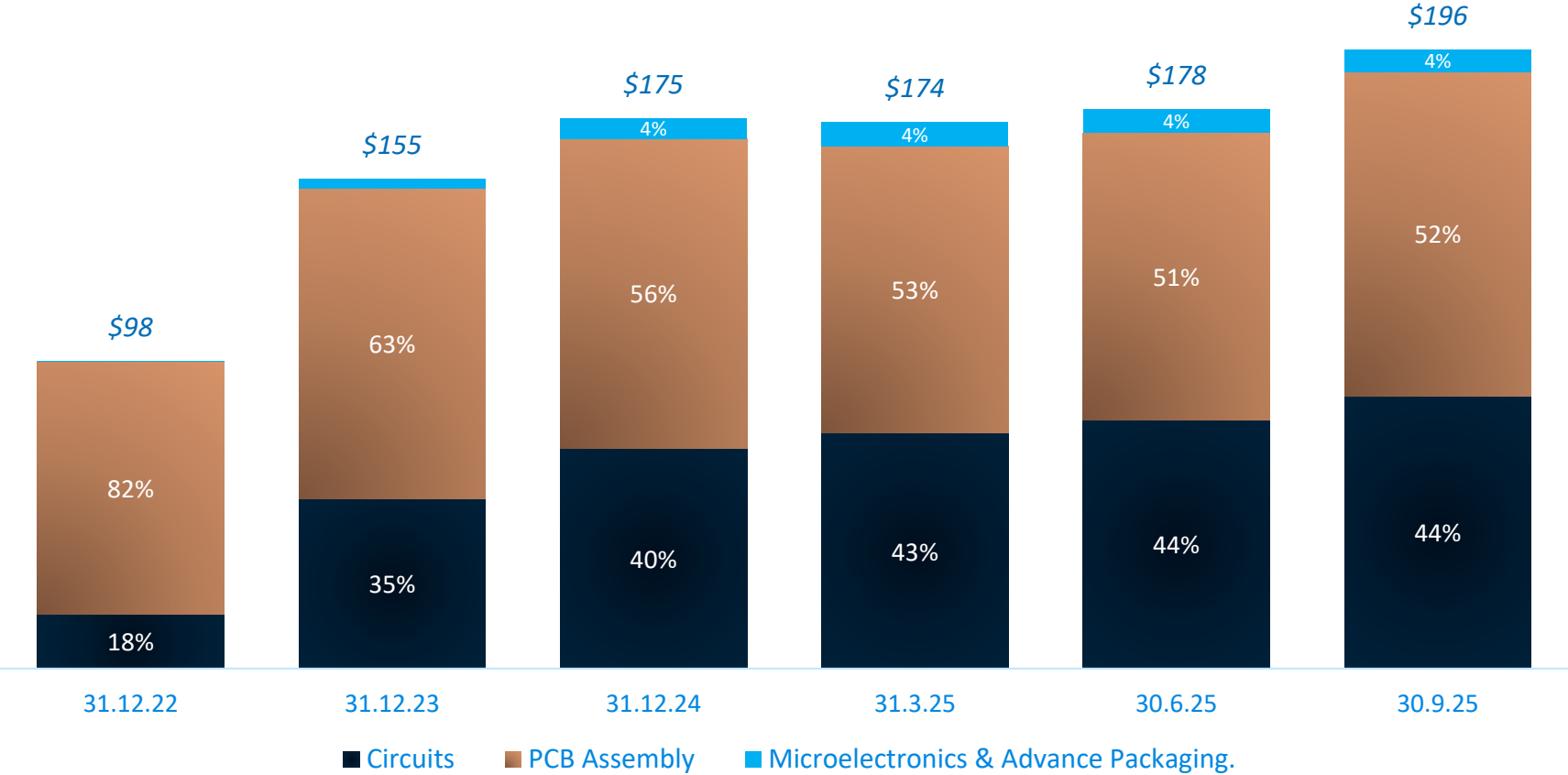
Assembly Division TTM GP K\$ Trend



CAGR GP TTM Q3-23 >> Q3-25: 130%



Backlog & Long Term Agreements (LTA) M\$

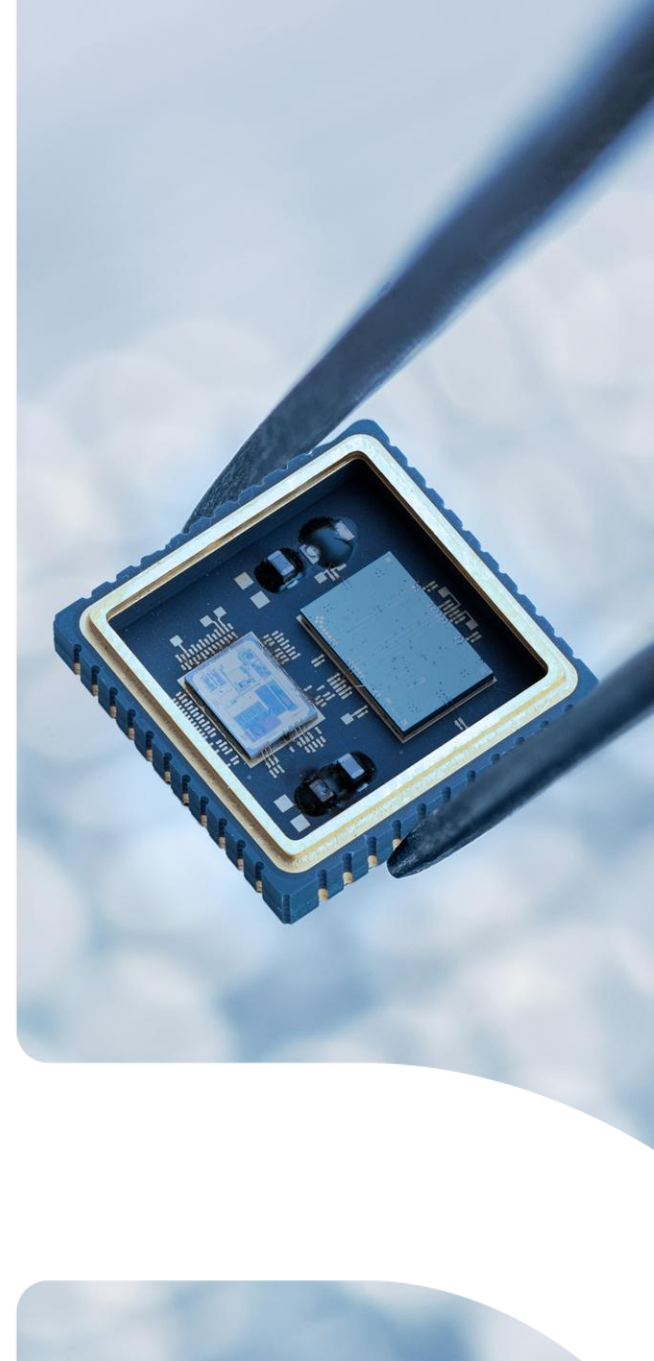


Information presented in this chart is based on dates adjacent to the release of the financial statements



Our Path Forward -Continued Growth

- A **strong backlog** ensures continued revenue growth across all divisions.
- We are **involved in major programs** within the Defense & Aerospace, Medical, and Industrial Instruments sectors, serving key customers.
- The current **business climate**, influenced by geopolitical tensions, **drives demand** for advanced hardware electronics solutions in the Western market.
- Our **product mix emphasizes advanced technologies and miniaturization**, contributing to profit improvement.
- We are **expanding our capacity** through capital expenditures to address production bottlenecks and enhance operational efficiency.



Thank You

